

	<b>L #</b>	<b>Hits</b>	<b>Search Text</b>	<b>DBs</b>
<b>1</b>	<b>L1</b>	<b>6059</b>	(wiring adj board) and substrate and layers and electrodes	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
<b>2</b>	<b>L2</b>	<b>6</b>	(wiring adj board) and substrate and layers and electrodes and latice	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
<b>3</b>	<b>L3</b>	<b>1</b>	10/764522	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
<b>4</b>	<b>L4</b>	<b>2</b>	"20040243425"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT

	L #	Hits	Search Text	DBs
5	L5	2	"20040253425"	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
6	L6	2	("6887631").PN.	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
7	L7	6	("20030210361"   "5716740"   "6031512"   "6133062"   "6145981"   "6376872").PN.	US- PGPUB; USPAT; USOCR
8	L8	28419	multilayer and substrate and electrodes	US- PGPUB; USPAT; USOCR
9	L9	5050	multilayer and substrate and electrodes and overlap	US- PGPUB; USPAT; USOCR
10	L10	160	9 and (interconnect\$4 near3 pattern)	US- PGPUB; USPAT; USOCR
11	L11	5	("20040124770"   "20040183431"   "6787063"   "6809338"   "6815903").PN.	US- PGPUB; USPAT; USOCR

	<b>L #</b>	<b>Hits</b>	<b>Search Text</b>	<b>DBs</b>
<b>12</b>	L12	11	("20030122495"   "6290352"   "6304670"   "6312771"   "6323596"   "6341862"   "6342321"   "6364450"   "6386700"   "6394578"   "6646375").PN.	US- PGPUB; USPAT; USOCR
<b>13</b>	L13	9	("5459596"   "5510916"   "5940059"   "6066860"   "6075580"   "6108056"   "6172721"   "6320204"   "6610997").PN.	US- PGPUB; USPAT; USOCR

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	40	wiring adj board.ti. and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 12:54
L2	5	"174"/\$.ccls. and(wiring adj board. ti.) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 12:55
L3	22	"174"/\$.ccls. and(wiring adj board) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 13:03
L4	33	"361"/\$.ccls. and(wiring adj board) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 13:24
L5	19	"349"/\$.ccls. and(wiring adj board) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 13:27
L6	8	"365"/\$.ccls. and(wiring adj board) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 13:34
L7	27	electro adj optical adj device.ti. and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 14:25
L8	145	electro adj optical adj device.ti. and(bank)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 14:26

L9	15	8 and(interconnect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 14:26
S1	2562	wiring adj board and interconnecting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:39
S2	43	wiring adj board and interconnecting adj line	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:39
S3	1	S2 and(substrate with bank)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:45
S4	34	S2 and(substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:49
S5	370	aoki adj.koji.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:50
S6	11	S5 and(board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:54
S7	821	(361/306.1-306.3).ccls. and(wiring adj board or board or wir\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 18:01

S8	7	S7 and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:59
S9	1409	(174/252-254).ccls. and(wiring adj board or board or wir\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 18:02
S10	19	S9 and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 12:52